



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kazuo Nishiyama **Atty. Docket No.** 075834.00074
Serial No.: 09/ 843,630 **Group Art Unit:** 2812
Filed: April 27, 2001 **Examiner:** James M. Mitchell
Invention: CHIP-LIKE ELECTRONIC COMPONENTS, A METHOD OF MANUFACTURING THE SAME, A PSEUDO WAFER THEREFOR AND A METHOD OF MANUFACTURING THEREOF

DRAWING AMENDMENT

Commissioner of Patents
Washington, D.C. 20231

ATTN: Official Draftsman

SIR:

Applicant has attached proposed changes to Figures 9-12. The proposed changes are indicated in red ink. Applicant respectfully requests that the changes be accepted and entered in this application.

Respectfully submitted,


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Chicago, Illinois 60603
Tel: (312) 422-9050
Attorney for Applicant

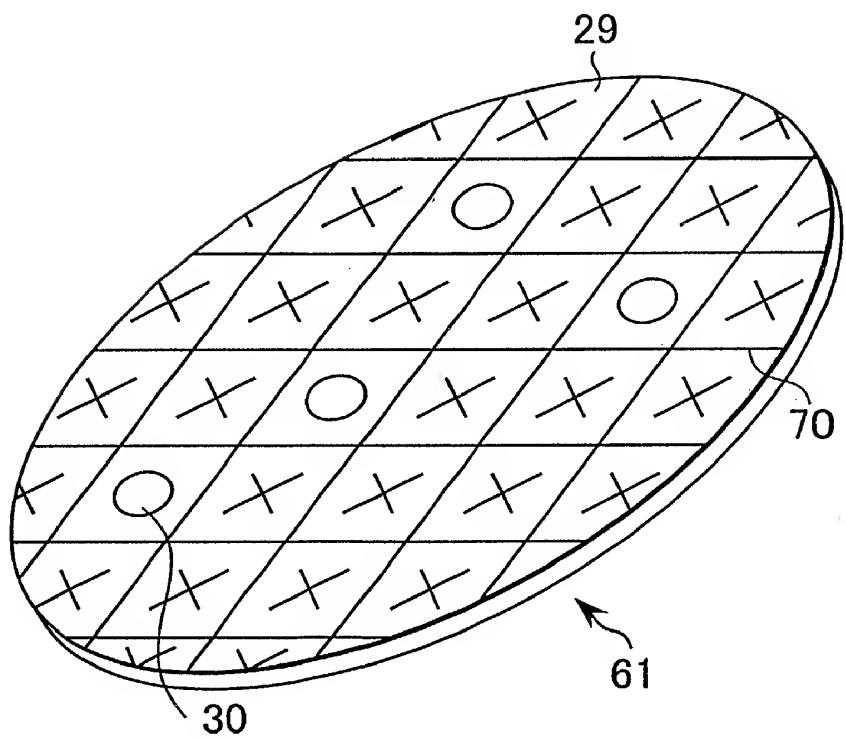
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Date: December 30, 2002



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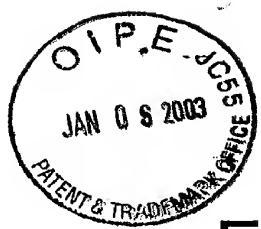
FIG.9



○:NON-DEFECTIVE CHIP

×:DEFECTIVE CHIP

Prior Art



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FIG.10A

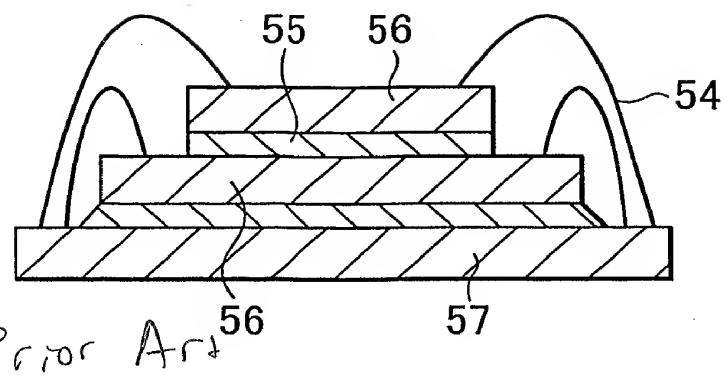


FIG.10B

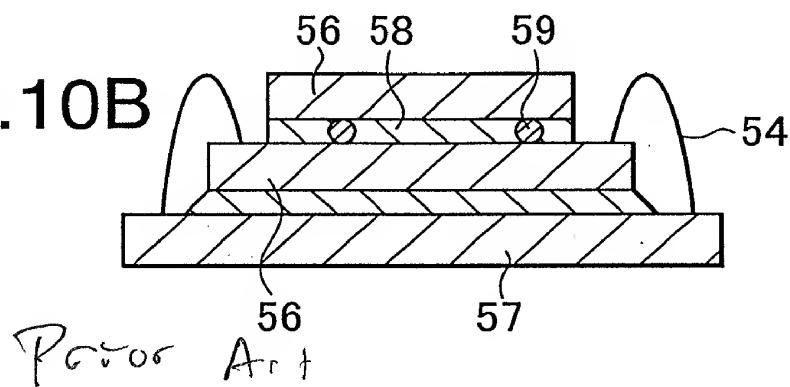
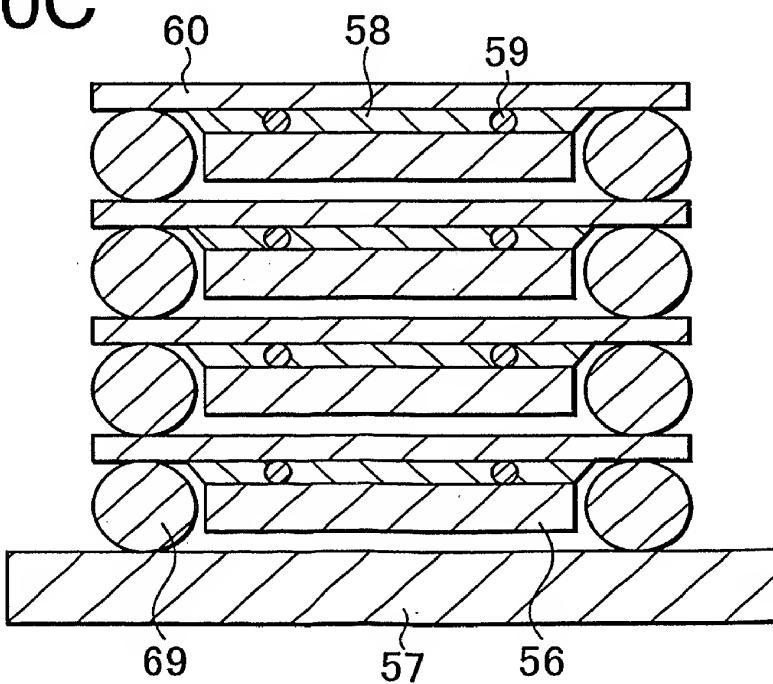


FIG.10C



Prior Art



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FIG.11A

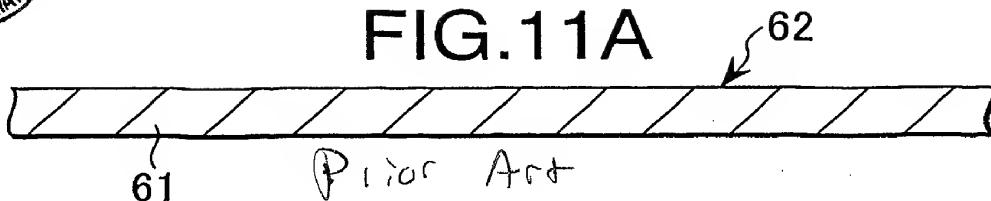


FIG.11B

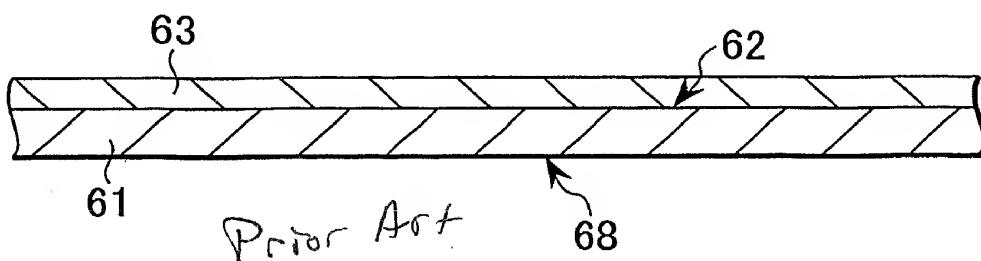


FIG.11C

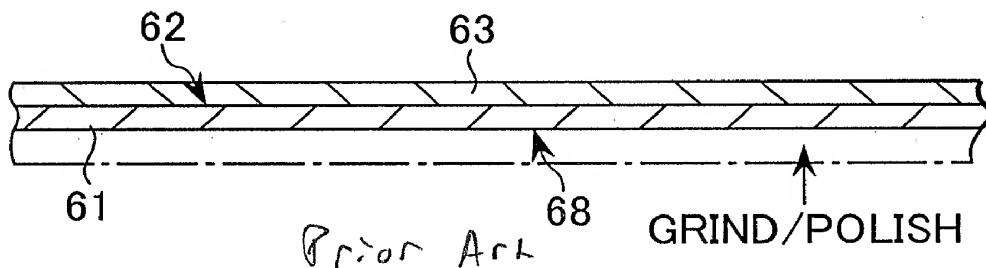


FIG.11D

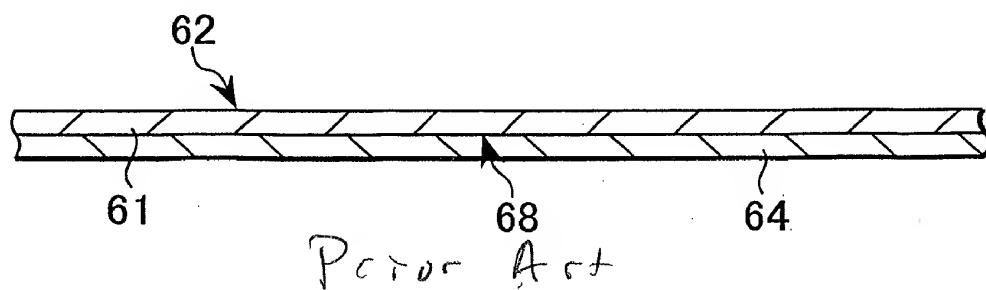
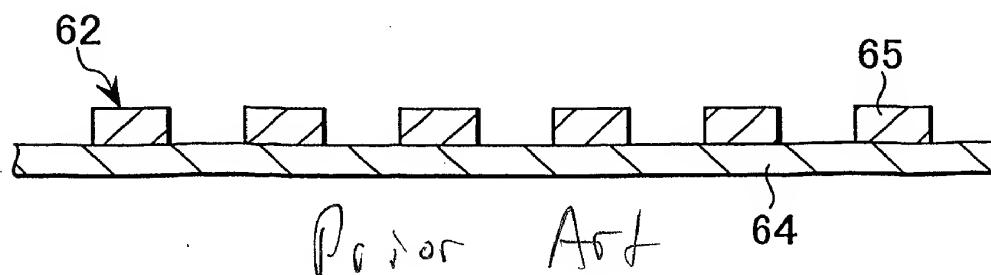


FIG.11E





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FIG.12A

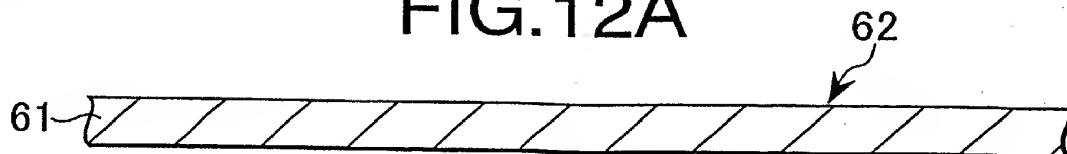


FIG.12B

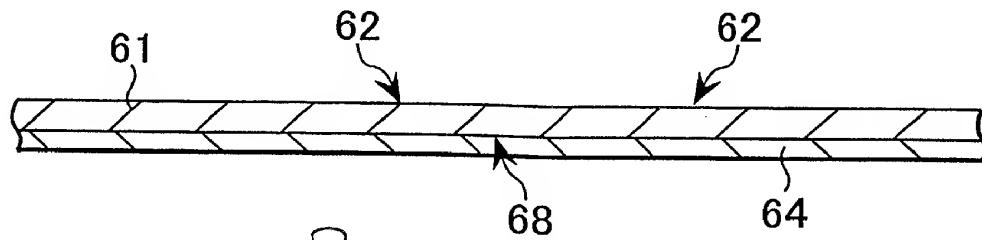


FIG.12C

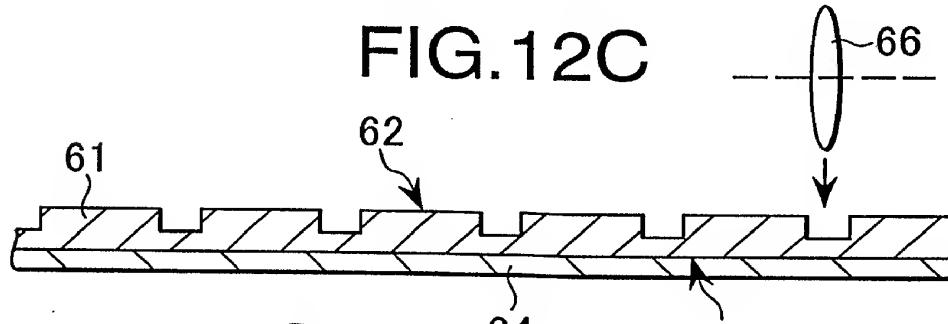


FIG.12D

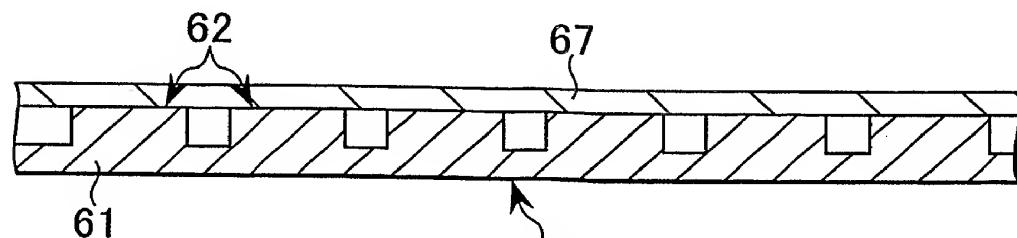
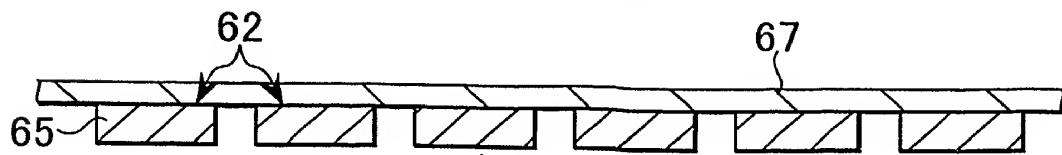


FIG.12E



Prior Art